

# XP152A11E5MR



Power MOS FET

- ◆ P-Channel Power MOS FET
- ◆ DMOS Structure
- ◆ Low On-State Resistance : 0.45Ω (max)
- ◆ Ultra High-Speed Switching
- ◆ Gate Protect Diode Built-in
- ◆ SOT-23 Package

## General Description

The XP152A11E5MR is a P-Channel Power MOS FET with low on-state resistance and ultra high-speed switching characteristics. Because high-speed switching is possible, the IC can be efficiently set thereby saving energy. In order to counter static, a gate protect diode is built-in. The small SOT-23 package makes high density mounting possible.

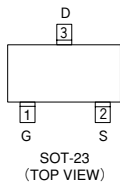
## Applications

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

## Features

- Low on-state resistance : Rds (on) = 0.25Ω ( Vgs = -10V )  
: Rds (on) = 0.45Ω ( Vgs = -4.5V )
- Ultra high-speed switching
- Gate Protect Diode Built-in
- Operational Voltage : -4.5V
- High density mounting : SOT-23

## Pin Configuration

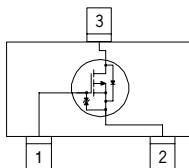


## Pin Assignment

PIN NUMBER	PIN NAME	FUNCTION
1	G	Gate
2	S	Source
3	D	Drain

11

## Equivalent Circuit



P-Channel MOS FET  
( 1 device built-in )

## Absolute Maximum Ratings

Ta=25°C			
PARAMETER	SYMBOL	RATINGS	UNITS
Drain - Source Voltage	Vdss	-30	V
Gate - Source Voltage	Vgss	± 20	V
Drain Current (DC)	Id	-0.7	A
Drain Current (Pulse)	Idp	-2.8	A
Reverse Drain Current	Idr	-0.7	A
Continuous Channel Power Dissipation (note)	Pd	0.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 - 150	°C

( note ) : When implemented on a ceramic PCB

## XP152A11E5MR

### Electrical Characteristics

#### DC Characteristics

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Drain Cut-off Current	Idss	Vds = - 30V , Vgs = 0V			- 10	μA
Gate-Source Leakage Current	Igss	Vgs = ± 20V , Vds = 0V			± 10	μA
Gate-Source Cut-off Voltage	Vgs ( off )	Id = -1mA , Vds = - 10V	- 1.0		- 3.0	V
Drain-Source On-state Resistance ( note )	Rds ( on )	Id = - 0.4A , Vgs = - 10V		0.2	0.25	Ω
		Id = - 0.4A , Vgs = - 4.5V		0.35	0.45	Ω
Forward Transfer Admittance ( note )	Yfs	Id = - 0.4A , Vds = - 10V		1		S
Body Drain Diode Forward Voltage	Vf	If = - 0.7A , Vgs = 0V		-0.8	- 1.1	V

( note ) : Effective during pulse test.

#### Dynamic Characteristics

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Capacitance	Ciss	Vds = - 10V , Vgs = 0V f = 1 MHz		160		pF
Output Capacitance	Coss			120		pF
Feedback Capacitance	Crss			50		pF

#### Switching Characteristics

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Turn-on Delay Time	td ( on )	Vgs = - 5V , Id = - 0.4A Vdd = - 10V		10		ns
Rise Time	tr			25		ns
Turn-off Delay Time	td ( off )			25		ns
Fall Time	tf			40		ns

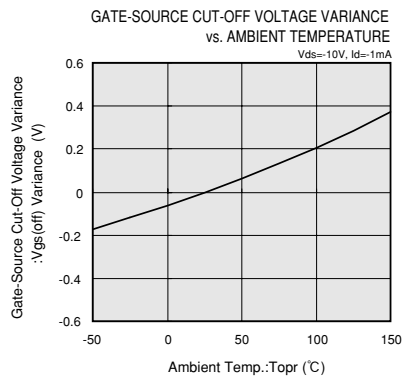
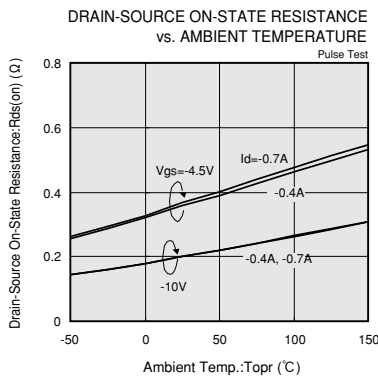
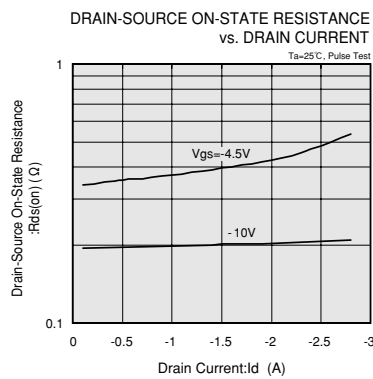
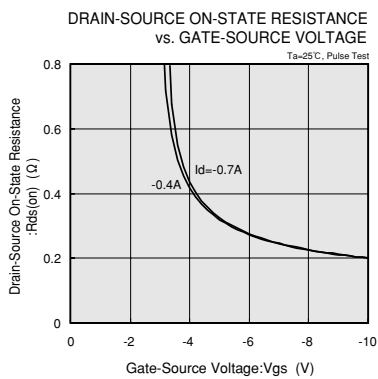
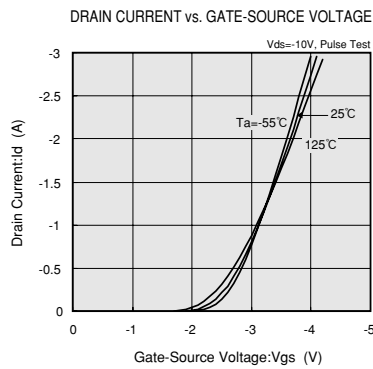
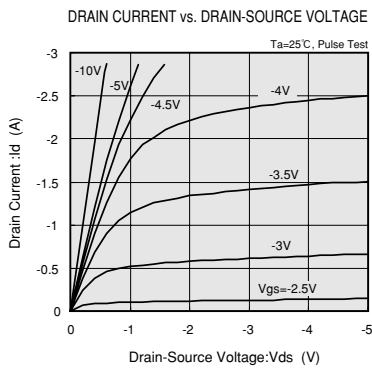
#### Thermal Characteristics

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Thermal Resistance ( channel-ambience )	Rth ( ch-a )	Implement on a ceramic PCB		250		°C / W

11

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## Typical Performance Characteristics



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